

# DATA SHEET

**74ABT16373B**

**74ABTH16373B**

16-bit transparent latch (3-State)

Product specification  
Supersedes data of 1995 Aug 03  
IC23 Data Handbook

1998 Feb 27

# 16-bit transparent latch (3-State)

## 74ABT16373B 74ABTH16373B

### FEATURES

- 16-bit transparent latch
- Multiple  $V_{CC}$  and GND pins minimize switching noise
- Power-up 3-State
- Live insertion/extraction permitted
- Power-up reset
- 3-State output buffers
- 74ABTH16373B incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Output capability: +64mA/−32mA
- $I_{CCL}$  −19 mA maximum
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

### DESCRIPTION

The 74ABT16373B high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16373B device is a dual octal transparent latch coupled to two sets of eight 3-State output buffers. The two sections of the device are controlled independently by Enable (nE) and Output Enable (nOE) control gates.

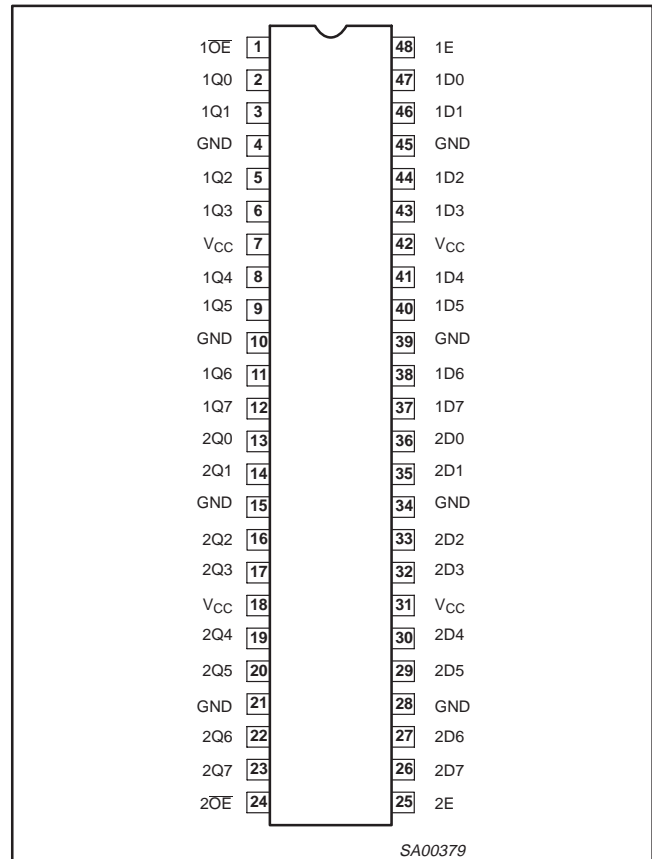
The data on each set of D inputs are transferred to the latch outputs when the Latch Enable (nE) input is High. The latch remains transparent to the data inputs while nE is High, and stores the data that is present one setup time before the High-to-Low enable transition.

The 3-State output buffers are designed to drive heavily loaded 3-State buses, MOS memories, or MOS microprocessors. Each active-Low Output Enable (nOE) controls eight 3-State buffers independent of the latch operation.

When nOE is Low, the latched or transparent data appears at the outputs. When nOE is High, the outputs are in the High-impedance "OFF" state, which means they will neither drive nor load the bus.

Two options are available, 74ABT16373B which does not have the bus-hold feature and 74ABTH16373B which incorporates the bus-hold feature.

### PIN CONFIGURATION



### QUICK REFERENCE DATA

| SYMBOL                 | PARAMETER                     | CONDITIONS<br>$T_{amb} = 25^{\circ}\text{C}; \text{GND} = 0\text{V}$ | TYPICAL    | UNIT          |
|------------------------|-------------------------------|--|------------|---------------|
| $t_{PLH}$<br>$t_{PHL}$ | Propagation delay<br>Dn to Qn | $C_L = 50\text{pF}; V_{CC} = 5\text{V}$                              | 2.5<br>2.0 | ns            |
| $C_{IN}$               | Input capacitance             | $V_I = 0\text{V}$ or $V_{CC}$  | 4          | pF            |
| $C_{OUT}$              | Output capacitance            | $V_O = 0\text{V}$ or $V_{CC}$ ; 3-State                              | 7          | pF            |
| $I_{CCZ}$              | Quiescent supply current      | Outputs disabled; $V_{CC} = 5.5\text{V}$                             | 500        | $\mu\text{A}$ |
| $I_{CCL}$              |                               | Outputs low; $V_{CC} = 5.5\text{V}$                                  | 8          | mA            |

### ORDERING INFORMATION

| PACKAGES             | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|----------------------|-------------------|-----------------------|---------------|------------|
| 48-Pin SSOP type III | −40°C to +85°C    | 74ABT16373B DL        | BT16373B DL   | SOT370-1   |
| 48-Pin TSSOP type II | −40°C to +85°C    | 74ABT16373B DGG       | BT16373B DGG  | SOT362-1   |
| 48-Pin SSOP type III | −40°C to +85°C    | 74ABTH16373B DL       | BH16373B DL   | SOT370-1   |
| 48-Pin TSSOP type II | −40°C to +85°C    | 74ABTH16373B DGG      | BH16373B DGG  | SOT362-1   |

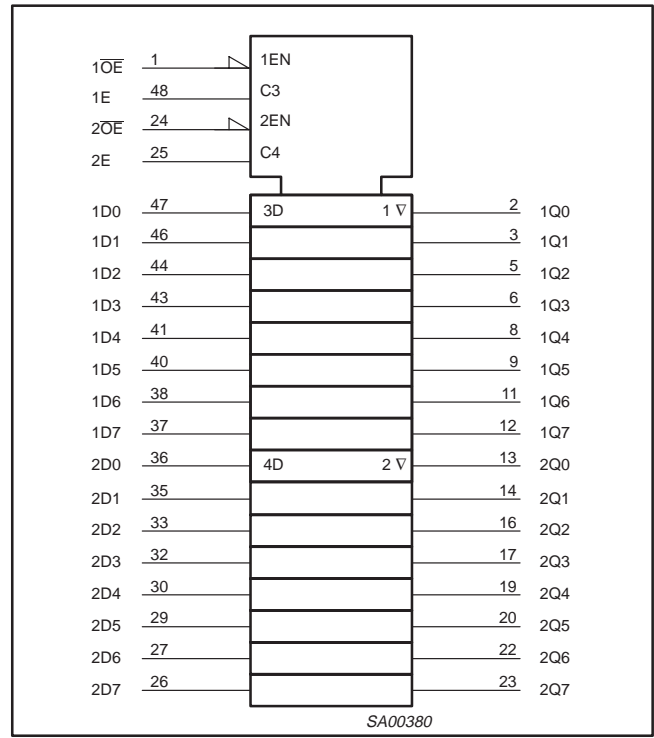
# 16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

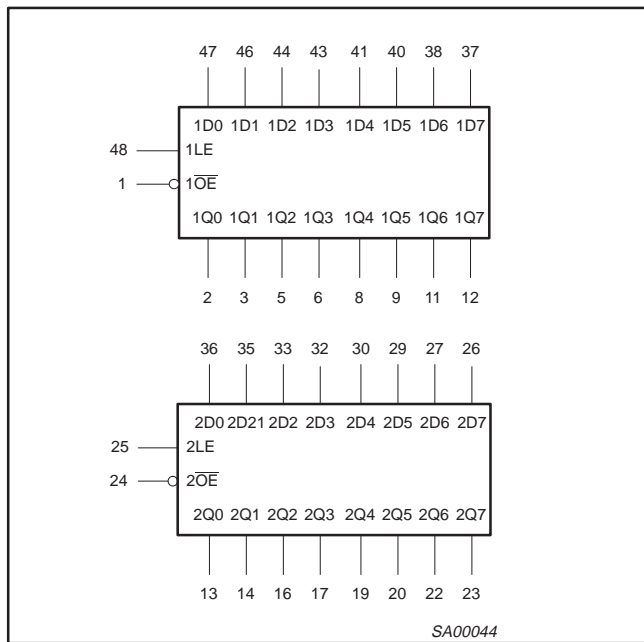
## PIN DESCRIPTION

| PIN NUMBER   | SYMBOL                 | FUNCTION                          |
|--|------------------------|-----------------------------------|
| 47, 46, 44, 43, 41, 40, 38, 37, 36, 35, 33, 32, 30, 29, 27, 26 | 1D0 – 1D7<br>2D0 – 2D7 | Data inputs                       |
| 2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17, 19, 20, 22, 23       | 1Q0 – 1Q7<br>2Q0 – 2Q7 | Data outputs                      |
| 1, 24  | 1OE, 2OE               | Output enable inputs (active-Low) |
| 48, 25   | 1E, 2E                 | Enable inputs (active-High)       |
| 4, 10, 15, 21, 28, 34, 39, 45                                  | GND                    | Ground (0V)                       |
| 7, 18, 31, 42  | V <sub>CC</sub>        | Positive supply voltage           |

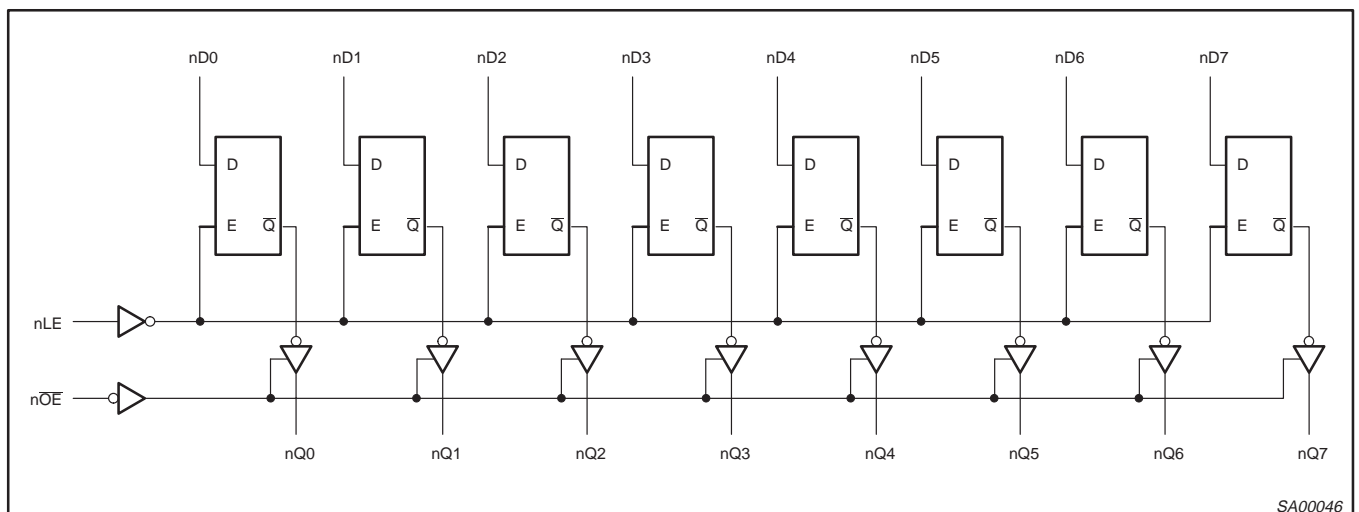
## LOGIC SYMBOL (IEEE/IEC)



## LOGIC SYMBOL



## LOGIC DIAGRAM



## 16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

## FUNCTION TABLE

| INPUTS |        |         | INTERNAL REGISTER | OUTPUTS   | OPERATING MODE           |
|--------|--------|---------|-------------------|-----------|--------------------------|
| nOE    | nE     | nDx     |                   | nQ0 – nQ7 |                          |
| L<br>L | H<br>H | L<br>H  | L<br>H            | L<br>H    | Enable and read register |
| L<br>L | ↓<br>↓ | i<br>h  | L<br>H            | L<br>H    | Latch and read register  |
| L      | L      | X       | NC                | NC        | Hold                     |
| H<br>H | L<br>H | X<br>Dn | NC<br>Dn          | Z<br>Z    | Disable outputs          |

H = High voltage level

h = High voltage level one set-up time prior to the High-to-Low E transition

L = Low voltage level

l = Low voltage level one set-up time prior to the High-to-Low E transition

NC= No change

X = Don't care

Z = High impedance "off" state

↓ = High-to-Low E transition

ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

| SYMBOL           | PARAMETER                      | CONDITIONS                  | RATING       | UNIT |
|------------------|--------------------------------|-----------------------------|--------------|------|
| V <sub>CC</sub>  | DC supply voltage              |                             | -0.5 to +7.0 | V    |
| I <sub>IK</sub>  | DC input diode current         | V <sub>I</sub> < 0          | -18          | mA   |
| V <sub>I</sub>   | DC input voltage <sup>3</sup>  |                             | -1.2 to +7.0 | V    |
| I <sub>OK</sub>  | DC output diode current        | V <sub>O</sub> < 0          | -50          | mA   |
| V <sub>OUT</sub> | DC output voltage <sup>3</sup> | output in Off or High state | -0.5 to +5.5 | V    |
| I <sub>OUT</sub> | DC output current              | output in Low state         | 128          | mA   |
|                  |                                | output in High state        | -64          |      |
| T <sub>stg</sub> | Storage temperature range      |                             | -65 to 150   | °C   |

## NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## RECOMMENDED OPERATING CONDITIONS

| SYMBOL           | PARAMETER                            | LIMITS |                 | UNIT |
|------------------|--------------------------------------|--------|-----------------|------|
|                  |                                      | MIN    | MAX             |      |
| V <sub>CC</sub>  | DC supply voltage                    | 4.5    | 5.5             | V    |
| V <sub>I</sub>   | Input voltage                        | 0      | V <sub>CC</sub> | V    |
| V <sub>IH</sub>  | High-level input voltage             | 2.0    |                 | V    |
| V <sub>IL</sub>  | Low-level Input voltage              |        | 0.8             | V    |
| I <sub>OH</sub>  | High-level output current            |        | -32             | mA   |
| I <sub>OL</sub>  | Low-level output current             |        | 64              | mA   |
| Δt/Δv            | Input transition rise or fall rate   | 0      | 10              | ns/V |
| T <sub>amb</sub> | Operating free-air temperature range | -40    | +85             | °C   |

## 16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

## DC ELECTRICAL CHARACTERISTICS

| SYMBOL                           | PARAMETER  | TEST CONDITIONS  | LIMITS                   |       |      |                                   |      | UNIT |
|----------------------------------|--|--|--------------------------|-------|------|-----------------------------------|------|------|
|                                  |  |  | T <sub>amb</sub> = +25°C |       |      | T <sub>amb</sub> = -40°C to +85°C |      |      |
|                                  |  |  | MIN                      | TYP   | MAX  | MIN                               | MAX  |      |
| V <sub>IK</sub>                  | Input clamp voltage  | V <sub>CC</sub> = 4.5V; I <sub>IK</sub> = -18mA  |                          | -0.9  | -1.2 |                                   | -1.2 | V    |
| V <sub>OH</sub>                  | High-level output voltage  | V <sub>CC</sub> = 4.5V; I <sub>OH</sub> = -3mA; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>            | 2.5                      | 2.9   |      | 2.5                               |      | V    |
|                                  |  | V <sub>CC</sub> = 5.0V; I <sub>OH</sub> = -3mA; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>            | 3.0                      | 3.4   |      | 3.0                               |      | V    |
|                                  |  | V <sub>CC</sub> = 4.5V; I <sub>OH</sub> = -32mA; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>           | 2.0                      | 2.4   |      | 2.0                               |      | V    |
| V <sub>OL</sub>                  | Low-level output voltage   | V <sub>CC</sub> = 4.5V; I <sub>OL</sub> = 64mA; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>            |                          | 0.42  | 0.55 |                                   | 0.55 | V    |
| V <sub>RST</sub>                 | Power-up output voltage <sup>3</sup>                                 | V <sub>CC</sub> = 5.5V; I <sub>O</sub> = 1mA; V <sub>I</sub> = GND or V <sub>CC</sub>                          |                          | 0.13  | 0.55 |                                   | 0.55 | V    |
| I <sub>I</sub>                   | Input leakage current<br>74ABT16373B                                 | V <sub>CC</sub> = 5.5V; V <sub>I</sub> = V <sub>CC</sub> or GND  |                          | ±0.01 | ±1   |                                   | ±1   | µA   |
| I <sub>I</sub>                   | Input leakage current<br>74ABTH16373B                                | V <sub>CC</sub> = 5.5V; V <sub>I</sub> = V <sub>CC</sub> or GND  | Control pins             | ±0.01 | ±1   |                                   | ±1   | µA   |
|                                  |  | V <sub>CC</sub> = 5.5V; V <sub>I</sub> = V <sub>CC</sub>   | Data pins <sup>5</sup>   | 0.01  | 1    |                                   | 1    | µA   |
|                                  |  | V <sub>CC</sub> = 5.5V; V <sub>I</sub> = 0   |                          | -1    | -3   |                                   | -5   | µA   |
| I <sub>HOLD</sub>                | Bus Hold current A inputs <sup>6</sup><br>74ABTH16373B               | V <sub>CC</sub> = 4.5V; V <sub>I</sub> = 0.8V  |                          | 50    |      | 50                                |      | µA   |
|                                  |  | V <sub>CC</sub> = 4.5V; V <sub>I</sub> = 2.0V  |                          | -75   |      | -75                               |      |      |
|                                  |  | V <sub>CC</sub> = 5.5V; V <sub>I</sub> = 0 to 5.5V   |                          | ±800  |      |                                   |      |      |
| I <sub>OFF</sub>                 | Power-off leakage current  | V <sub>CC</sub> = 0.0V; V <sub>O</sub> or V <sub>I</sub> ≤ 4.5V  |                          | ±5.0  | ±100 |                                   | ±100 | µA   |
| I <sub>PU</sub> /I <sub>PD</sub> | Power-up/down 3-State output current <sup>4</sup>                    | V <sub>CC</sub> = 2.1V; V <sub>O</sub> = 0.5V; V <sub>I</sub> = GND or V <sub>CC</sub> ; V <sub>OE</sub> = GND |                          | ±5.0  | ±50  |                                   | ±50  | µA   |
| I <sub>OZH</sub>                 | 3-State output High current  | V <sub>CC</sub> = 5.5V; V <sub>O</sub> = 5.5V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>             |                          | 0.5   | 10   |                                   | 10   | µA   |
| I <sub>OZL</sub>                 | 3-State output Low current   | V <sub>CC</sub> = 5.5V; V <sub>O</sub> = 0.0V; V <sub>I</sub> = V <sub>IL</sub> or V <sub>IH</sub>             |                          | -0.5  | -10  |                                   | -10  | µA   |
| I <sub>O</sub>                   | Output current <sup>1</sup>  | V <sub>CC</sub> = 5.5V; V <sub>O</sub> = 2.5V  | -50                      | -70   | -180 | -50                               | -180 | mA   |
| I <sub>CEX</sub>                 | Output High leakage current  | V <sub>CC</sub> = 5.5V; V <sub>O</sub> = 5.5V; V <sub>I</sub> = GND or V <sub>CC</sub>                         |                          | 0.1   | 50   |                                   | 50   | µA   |
| I <sub>CCH</sub>                 | Quiescent supply current   | V <sub>CC</sub> = 5.5V; Outputs High, V <sub>I</sub> = GND or V <sub>CC</sub>                                  |                          | 0.5   | 2    |                                   | 2    | mA   |
| I <sub>CCL</sub>                 |  | V <sub>CC</sub> = 5.5V; Outputs Low, V <sub>I</sub> = GND or V <sub>CC</sub>                                   |                          | 8     | 19   |                                   | 19   | mA   |
| I <sub>CCZ</sub>                 |  | V <sub>CC</sub> = 5.5V; Outputs 3-State; V <sub>I</sub> = GND or V <sub>CC</sub>                               |                          | 0.5   | 2    |                                   | 2    | mA   |
| ΔI <sub>CC</sub>                 | Additional supply current per input pin <sup>2</sup><br>74ABT16373B  | V <sub>CC</sub> = 5.5V; one input at 3.4V, other inputs at V <sub>CC</sub> or GND                              |                          | 5     | 100  |                                   | 100  | µA   |
| ΔI <sub>CC</sub>                 | Additional supply current per input pin <sup>2</sup><br>74ABTH16373B | V <sub>CC</sub> = 5.5V; one input at 3.4V, other inputs at V <sub>CC</sub> or GND                              |                          | 0.5   | 1.5  |                                   | 1.5  | mA   |

## NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input at 3.4V.
- For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
- This parameter is valid for any V<sub>CC</sub> between 0V and 2.1V, with a transition time of up to 10msec. From V<sub>CC</sub> = 2.1 to V<sub>CC</sub> = 5V ± 10% a transition time of up to 100µsec is permitted.
- Unused pins at V<sub>CC</sub> or GND.
- This is the bus hold overdrive current required to force the input to the opposite logic state.

# 16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

## AC CHARACTERISTICS

GND = 0V,  $t_R = t_F = 2.5\text{ns}$ ,  $C_L = 50\text{pF}$ ,  $R_L = 500\Omega$

| SYMBOL                               | PARAMETER                                      | WAVEFORM | LIMITS   |            |            |  |            | UNIT |
|--------------------------------------|--|----------|--|------------|------------|--|------------|------|
|                                      |  |          | $T_{\text{amb}} = +25^\circ\text{C}$<br>$V_{\text{CC}} = +5.0\text{V}$ |            |            | $T_{\text{amb}} = -40 \text{ to } +85^\circ\text{C}$<br>$V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$ |            |      |
|                                      |  |          | MIN  | TYP        | MAX        | MIN  | MAX        |      |
| $t_{\text{PLH}}$<br>$t_{\text{PHL}}$ | Propagation delay<br>nDx to nQx                | 2        | 1.5<br>1.1   | 2.5<br>2.0 | 3.8<br>3.1 | 1.5<br>1.1   | 4.4<br>3.8 | ns   |
| $t_{\text{PLH}}$<br>$t_{\text{PHL}}$ | Propagation delay<br>nE to nQx                 | 1        | 1.6<br>1.3   | 2.5<br>2.1 | 3.8<br>3.1 | 1.6<br>1.3   | 4.4<br>3.6 | ns   |
| $t_{\text{PZH}}$<br>$t_{\text{PZL}}$ | Output enable time<br>to High and Low level    | 4<br>5   | 1.2<br>1.3   | 2.3<br>2.3 | 3.5<br>3.5 | 1.2<br>1.3   | 4.6<br>4.5 | ns   |
| $t_{\text{PHZ}}$<br>$t_{\text{PLZ}}$ | Output disable time<br>from High and Low level | 4<br>5   | 1.9<br>1.7   | 3.1<br>2.6 | 4.5<br>3.8 | 1.9<br>1.7   | 5.3<br>4.2 | ns   |

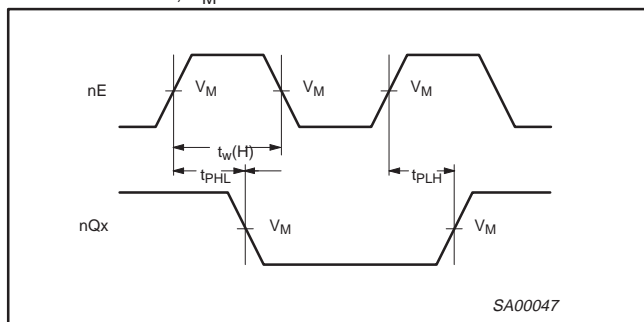
## AC SETUP REQUIREMENTS

GND = 0V,  $t_R = t_F = 2.5\text{ns}$ ,  $C_L = 50\text{pF}$ ,  $R_L = 500\Omega$

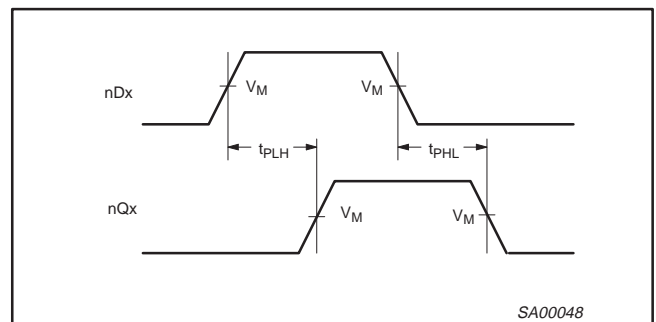
| SYMBOL                             | PARAMETER                            | WAVEFORM | LIMITS   |             |  | UNIT |
|------------------------------------|--------------------------------------|----------|--|-------------|--|------|
|                                    |                                      |          | $T_{\text{amb}} = +25^\circ\text{C}$<br>$V_{\text{CC}} = +5.0\text{V}$ |             | $T_{\text{amb}} = -40 \text{ to } +85^\circ\text{C}$<br>$V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$ |      |
|                                    |                                      |          | MIN  | TYP         | MIN  |      |
| $t_s(\text{H})$<br>$t_s(\text{L})$ | Setup time, High or Low<br>nDx to nE | 3        | 1.0<br>1.0   | 0.0<br>0.3  | 1.0<br>1.0   | ns   |
| $t_h(\text{H})$<br>$t_h(\text{L})$ | Hold time, High or Low<br>nDx to nE  | 3        | 0.5<br>0.5   | -0.2<br>0.0 | 0.5<br>0.5   | ns   |
| $t_w(\text{H})$                    | Enable pulse width<br>High           | 1        | 2.5  | 1.0         | 2.5  | ns   |

## AC WAVEFORMS

For all waveforms,  $V_M = 1.5\text{V}$ .



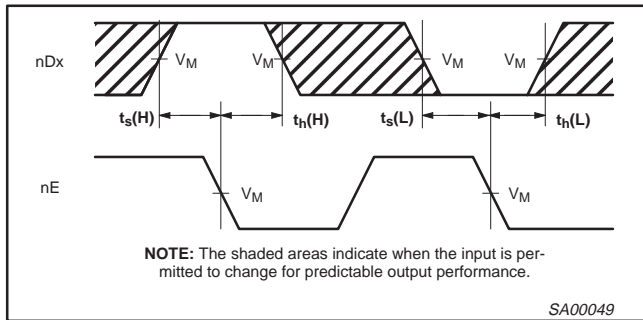
Waveform 1. Propagation Delay, Enable to Output, and Enable Pulse Width



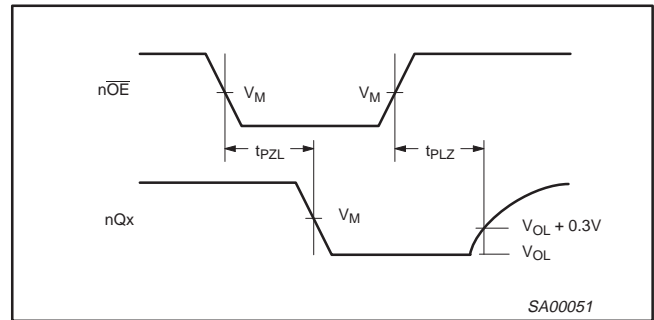
Waveform 2. Propagation Delay for Data to Outputs

# 16-bit transparent latch (3-State)

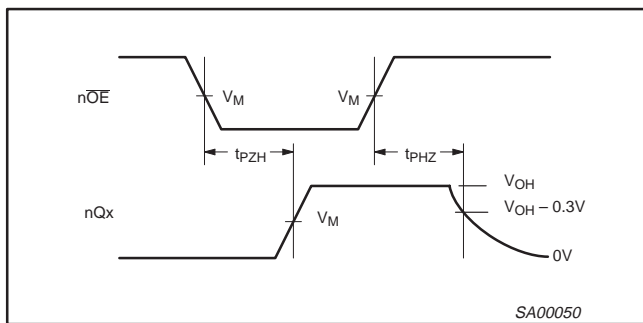
74ABT16373B  
74ABTH16373B



Waveform 3. Data Setup and Hold Times



Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level



Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level

## TEST CIRCUIT AND WAVEFORM

**Test Circuit for 3-State Outputs**

**SWITCH POSITION**

| TEST      | SWITCH |
|-----------|--------|
| $t_{PLZ}$ | closed |
| $t_{PZL}$ | closed |
| All other | open   |

**DEFINITIONS**

$R_L$  = Load resistor; see AC CHARACTERISTICS for value.  
 $C_L$  = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.  
 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

**Input Pulse Definition**

$V_M = 1.5V$

| FAMILY    | INPUT PULSE REQUIREMENTS |           |       |       |       |
|-----------|--------------------------|-----------|-------|-------|-------|
|           | Amplitude                | Rep. Rate | $t_W$ | $t_R$ | $t_F$ |
| 74ABT/H16 | 3.0V                     | 1MHz      | 500ns | 2.5ns | 2.5ns |

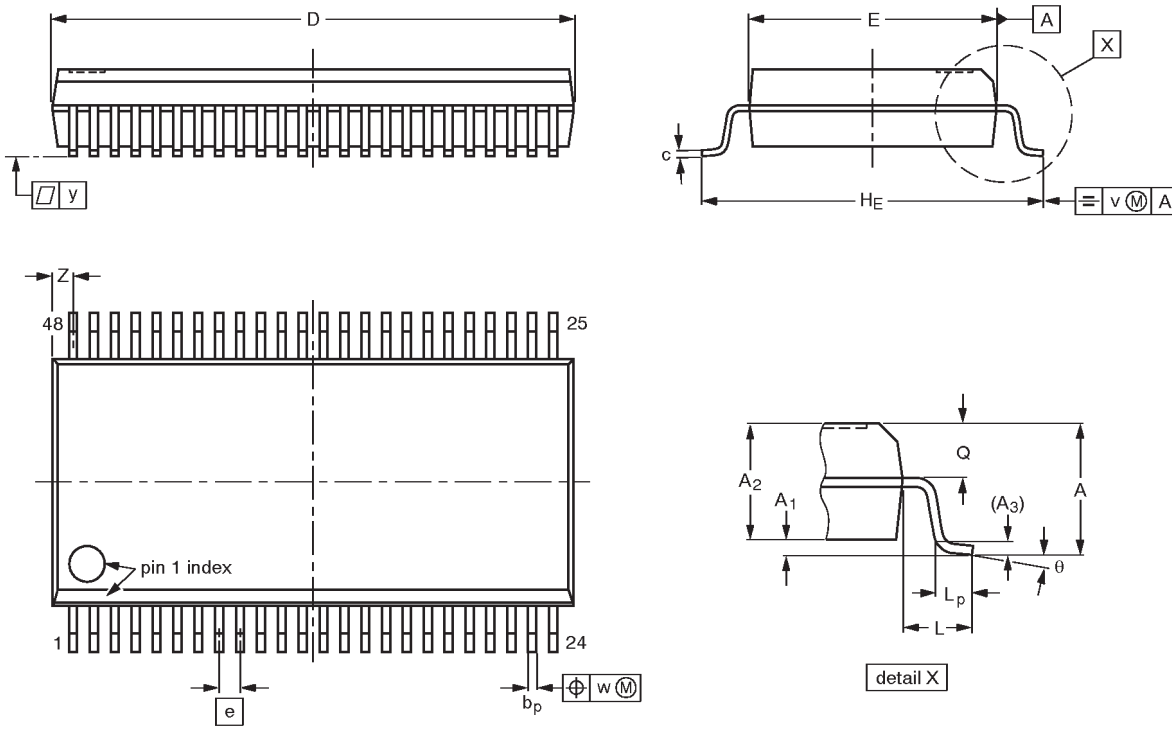
SA00018

16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



**DIMENSIONS (mm are the original dimensions)**

| UNIT | A max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c            | D <sup>(1)</sup> | E <sup>(1)</sup> | e     | H <sub>E</sub> | L   | L <sub>p</sub> | Q          | v    | w    | y   | Z <sup>(1)</sup> | θ        |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-------|----------------|-----|----------------|------------|------|------|-----|------------------|----------|
| mm   | 2.8    | 0.4<br>0.2     | 2.35<br>2.20   | 0.25           | 0.3<br>0.2     | 0.22<br>0.13 | 16.00<br>15.75   | 7.6<br>7.4       | 0.635 | 10.4<br>10.1   | 1.4 | 1.0<br>0.6     | 1.2<br>1.0 | 0.25 | 0.18 | 0.1 | 0.85<br>0.40     | 8°<br>0° |

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |          |      |  | EUROPEAN PROJECTION | ISSUE DATE             |
|-----------------|------------|----------|------|--|---------------------|------------------------|
|                 | IEC        | JEDEC    | EIAJ |  |                     |                        |
| SOT370-1        |            | MO-118AA |      |  |                     | -93-11-02-<br>95-02-04 |

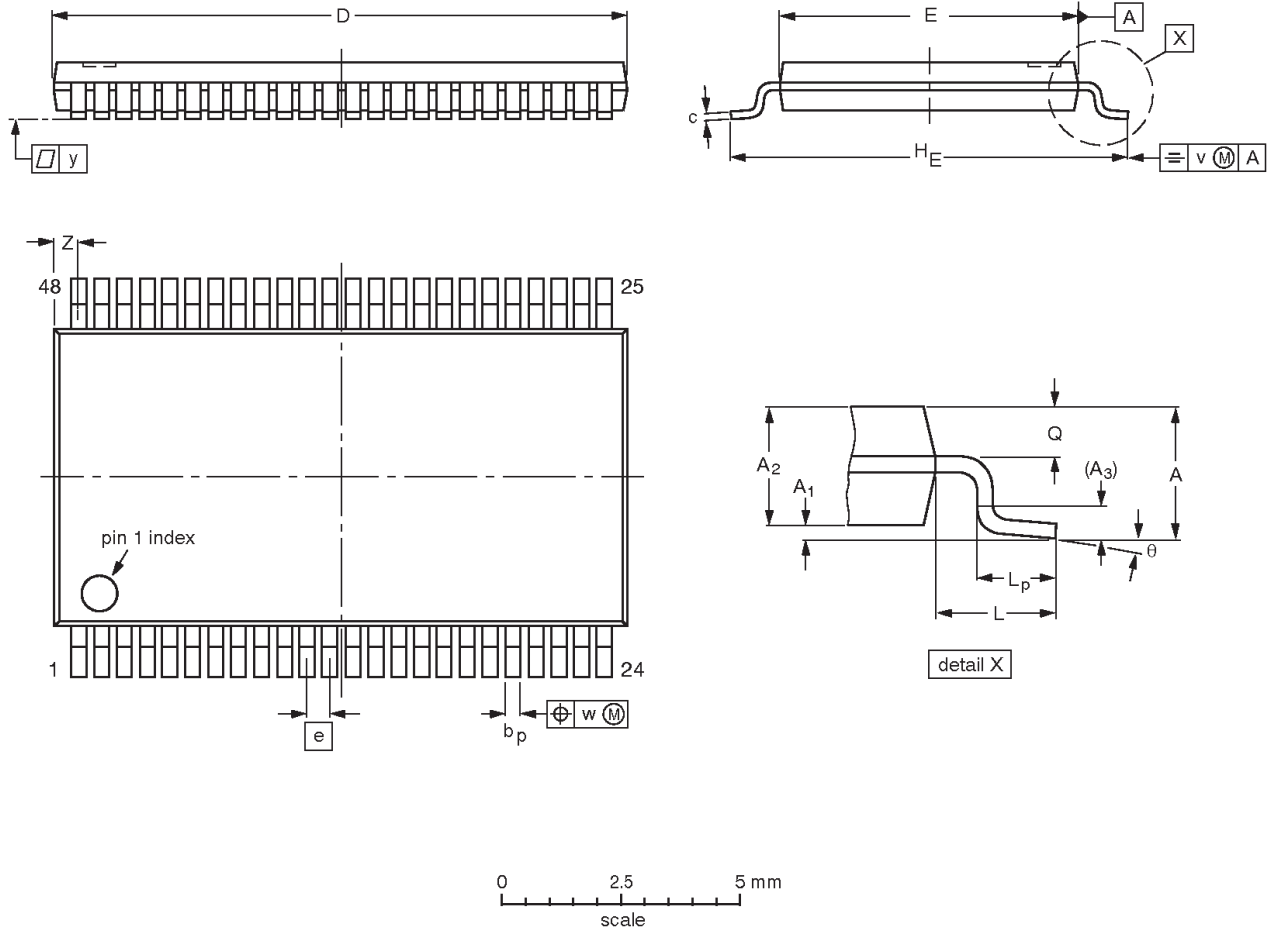


16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



**DIMENSIONS (mm are the original dimensions).**

| UNIT | A max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c          | D <sup>(1)</sup> | E <sup>(2)</sup> | e   | H <sub>E</sub> | L | L <sub>p</sub> | Q            | v    | w    | y   | Z          | θ        |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|-----|----------------|---|----------------|--------------|------|------|-----|------------|----------|
| mm   | 1.2    | 0.15<br>0.05   | 1.05<br>0.85   | 0.25           | 0.28<br>0.17   | 0.2<br>0.1 | 12.6<br>12.4     | 6.2<br>6.0       | 0.5 | 8.3<br>7.9     | 1 | 0.8<br>0.4     | 0.50<br>0.35 | 0.25 | 0.08 | 0.1 | 0.8<br>0.4 | 8°<br>0° |

**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |          |      |  | EUROPEAN PROJECTION | ISSUE DATE           |
|-----------------|------------|----------|------|--|---------------------|----------------------|
|                 | IEC        | JEDEC    | EIAJ |  |                     |                      |
| SOT362-1        |            | MO-153ED |      |  |                     | 93-02-03<br>95-02-10 |

## 16-bit transparent latch (3-State)

74ABT16373B  
74ABTH16373B

## Data sheet status

| Data sheet status         | Product status | Definition [1]   |
|---------------------------|----------------|--|
| Objective specification   | Development    | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.  |
| Preliminary specification | Qualification  | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
| Product specification     | Production     | This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.   |

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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print code

Date of release: 05-96

Document order number:

9397-750-03491

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